

STW21N150K5

N-channel 1500 V, 0.7 Ω typ.,14 A MDmesh™ K5 Power MOSFET in a TO-247 package

Datasheet - production data

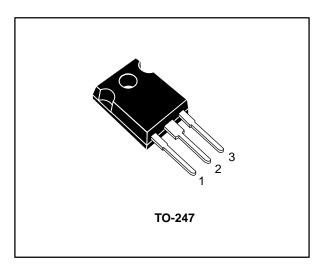
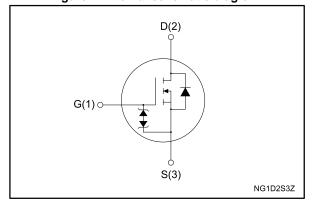


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	P _{TOT}
STW21N150K5	1500 V	0.9 Ω	14 A	446 W

- Industry's lowest R_{DS(on)} * area
- Industry's best figure of merit (FoM)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STW21N150K5	21N150K5	TO-247	Tube

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STW21N150K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	± 30	V
I_D	Drain current at T _C = 25 °C	14	Α
I _D	Drain current at T _C = 100 °C	8.7	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	56	Α
P _{TOT}	Total dissipation at T _C = 25 °C	446	W
dv/dt (2)	Peak diode recovery voltage slope	4.5	V/ns
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature	55 to 150	°C
T _{stg}	Storage temperature	- 55 to 150	C

Notes:

Table 3: Thermal data

Symbol Parameter		Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.28	°C/W
R _{thj-amb}	Thermal resistance junction-amb	50	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR} ⁽¹⁾	Max current during repetitive or single pulse avalanche	5	А
E _{AS} ⁽²⁾	Single pulse avalanche energy	1100	mJ

Notes:

⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}I_{SD} \le$ 14 A, di/dt \le 100 A/ μ s, $V_{Peak} \le V_{(BR)DSS}$

 $^{^{(3)}}V_{DS} \le 1200 \ V$

 $^{{}^{(1)}\}text{Pulse}$ width limited by $T_{J\text{max}}$

 $^{^{(2)}}Starting~T_J=25~^{\circ}C,~I_D=I_{AS},~V_{DD}=50~V$

Electrical characteristics STW21N150K5

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	1500			V
	Zaro goto voltogo droin	$V_{GS} = 0 \text{ V}, V_{DS} = 1500 \text{ V}$			1	μΑ
IDSS	Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 1500 V, T _C = 125 °C			50	μΑ
I _{GSS}	Gate body leakage current	$V_{DS} = 0$, $V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 7 A		0.7	0.9	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	3145	1	pF
Coss	Output capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V},$	-	172	ı	pF
Crss	Reverse transfer capacitance	f = 1 MHz	-	1	1	pF
C _{o(tr)} (1)	Equivalent capacitance time related	V 0 V 45 4200 V V 0 V	-	161	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	V _{DS} = 0 V to 1200 V, V _{GS} = 0 V	-	65	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	2.4	-	Ω
Qg	Total gate charge	V _{DD} = 1200 V, I _D = 7 A	-	89	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	16	1	nC
Q _{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	59	-	nC

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 750 V, I _D = 3.5 A,	ı	34	1	ns
tr	Rise time	$R_G = 4.7 \Omega V_{GS} = 10 V$	ı	14	ı	ns
t _{d(off)}	Turn-off delay time	(see Figure 17: "Unclamped	-	134	-	ns
t _f	Fall time	inductive load test circuit")	1	26	1	ns

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 $^{^{(2)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when VDS increases from 0 to 80% VDSS

Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isp	Source-drain current		-		7	Α
I _{SDM}	Source-drain current (pulsed)		-		28	Α
V _{SD} ⁽¹⁾	Forward on voltage	I _{SD} = 7 A, V _{GS} = 0 V	ı		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 7 \text{ A}, V_{DD} = 60 \text{ V}$	ı	448		ns
Qrr	Reverse recovery charge	$di/dt = 100 A/\mu s$,	-	8.24		μC
I _{RRM}	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	1	36.8		Α
t _{rr}	Reverse recovery time	$I_{SD} = 7 \text{ A}, V_{DD} = 60 \text{ V}$	-	564		ns
Qrr	Reverse recovery charge	di/dt = 100 A/μs,	-	9.48		μC
I _{RRM}	Reverse recovery current	Tj = 150 °C (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	•	33.6		А

Notes:

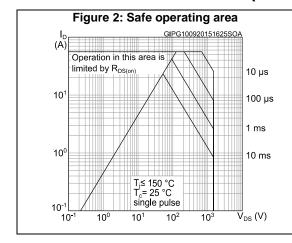
Table 9: Gate-source Zener diode

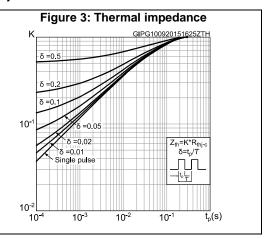
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _(BR) GSO	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30		-	V

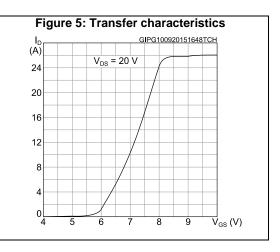
The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

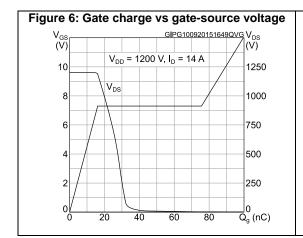
⁽¹⁾Pulsed: pulse duration = 300µs, duty cycle 1.5%

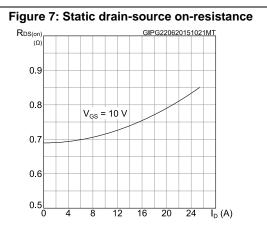
2.1 Electrical characteristics (curves)











STW21N150K5 Electrical characteristics

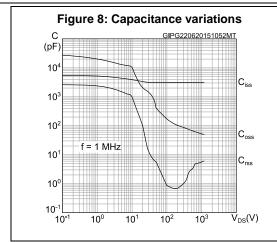
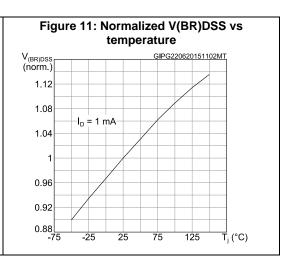
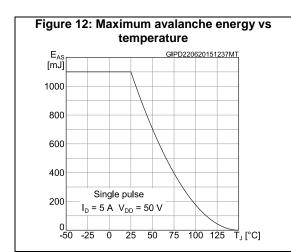
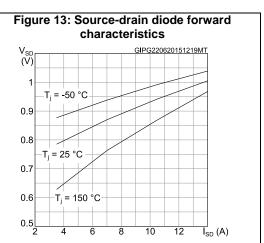


Figure 10: Normalized on-resistance vs temperature R_{DS(on)} (norm.) GIPG220620151224MT V_{GS}= 10 V 2.6 2.2 1.8 1.4 1.0 0.6 0.2L -75 25 75 125 ਰ¦(°C)





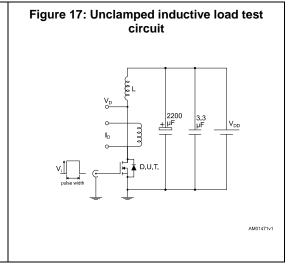


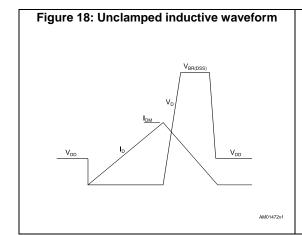
Test circuits STW21N150K5

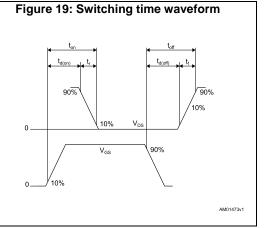
3 Test circuits

Figure 14: Test circuit for resistive load switching times

Figure 16: Test circuit for inductive load switching and diode recovery times







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STW21N150K5 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-247 package information

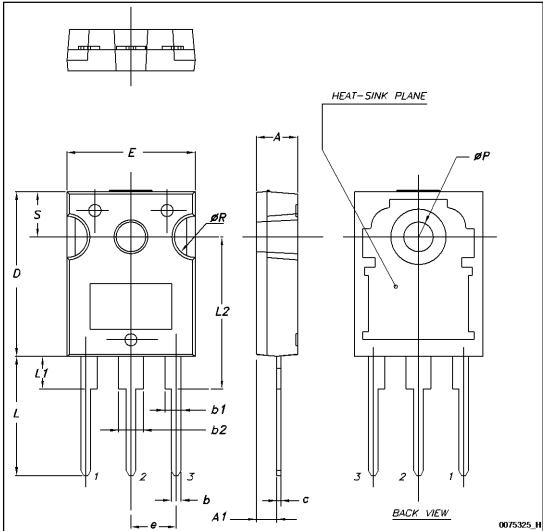


Figure 20: TO-247 package outline

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Table 10: TO-247 package mechanical data

		mm.	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

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STW21N150K5 Revision history

5 Revision history

Table 11: Document revision history

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Date	Revision	Changes
26-Aug-2015	1	First release.
10-Sep-2015	2	Text and formatting changes throughout document. Updated features on cover page. Updated sections Electrical ratings and Electrical characteristics. Added section Electrical characteristics (curves). Updated section TO-247 package information.
01-Oct-2015	3	On cover page: - updated figure Internal schematic diagram In section Electrical characteristics: - updated and renamed table Static (was On/off states).

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